

### SANYO Semiconductors

## DATA SHEET

N-Channel Silicon MOSFET

# BMS4003 — General-Purpose Switching Device Applications

#### **Features**

- ON-resistance  $RDS(on)=50m\Omega$  (typ.)
- Input capacitance Ciss=680pF (typ.)
- · 10V drive

### **Specifications**

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		100	V
Gate-to-Source Voltage	VGSS		±30	V
Drain Current (DC)	ID		18	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	72	А
Allowable Power Dissipation	Do		2.0	W
	PD	Tc=25°C	25	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		53	mJ
Avalanche Current *2	IAV		15	А

Note :\*1  $V_{DD}$ =60V, L=200 $\mu H$ ,  $I_{AV}$ =15A (Fig.1)

### **Package Dimensions**

unit : mm (typ) 7525-002

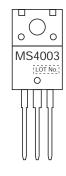
# 1: Gate 2: Drain 3: Source 2.55 2.55 2.55 2.8

### **Product & Package Information**

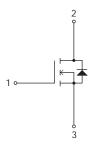
Package : TO-220ML(LS)JEITA, JEDEC : SC-67, SOT-186A

• Minimum Packing Quantity: 100 pcs./bag or 50pcs./magazine

### Marking



### **Electrical Connection**



<sup>\*2</sup> L≤200µH, Single pulse

### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Linit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	100			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	3		5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =9A		7.8		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =9A, V <sub>G</sub> S=10V		50	65	mΩ
Input Capacitance	Ciss			680		pF
Output Capacitance	Coss	V <sub>DS</sub> =20V, f=1MHz		130		pF
Reverse Transfer Capacitance	Crss			33		pF
Turn-ON Delay Time	t <sub>d</sub> (on)			16		ns
Rise Time	t <sub>r</sub>	Cara Film 2		33		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See Fig.2		27		ns
Fall Time	tf			15		ns
Total Gate Charge	Qg	V <sub>DS</sub> =60V, V <sub>GS</sub> =10V, I <sub>D</sub> =18A		11.4		nC
Gate-to-Source Charge	Qgs			4.1		nC
Gate-to-Drain "Miller" Charge	Qgd			3.8		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =18A, V <sub>GS</sub> =0V		0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	See Fig.3		60		ns
Reverse Recovery Charge	Q <sub>rr</sub>	IS=18A, VGS=0V, di/dt=100A/μs		114		nC

Fig.1 Avalanche Resistance Test Circuit

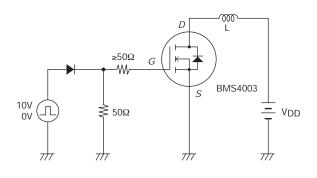


Fig.2 Switching Time Test Circuit

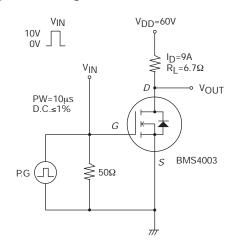
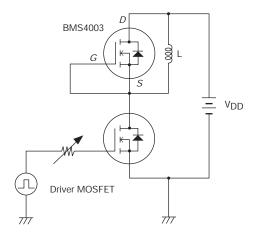
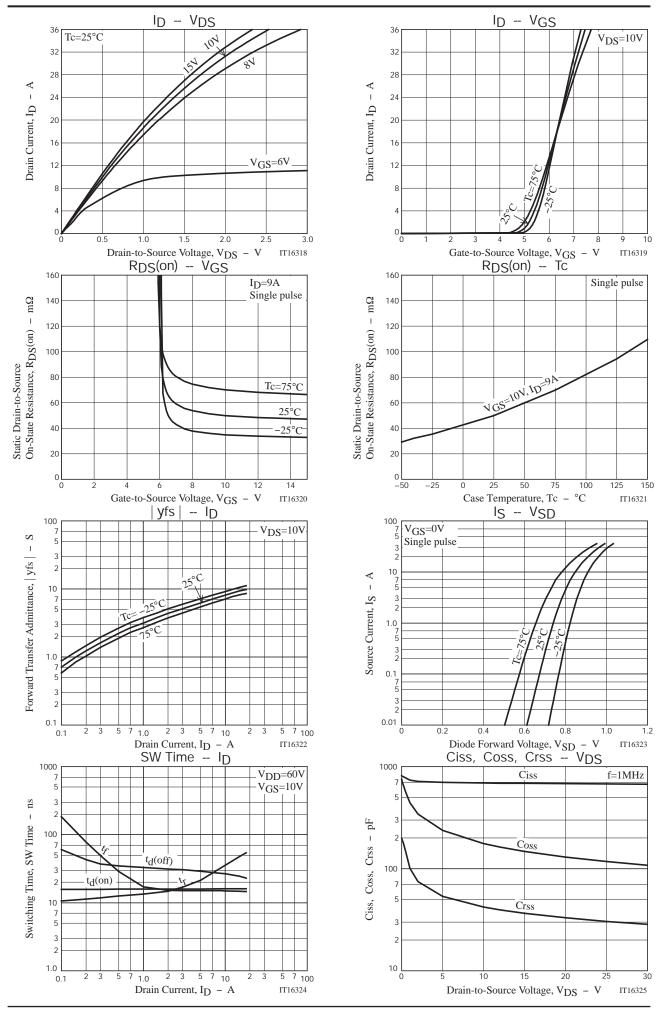
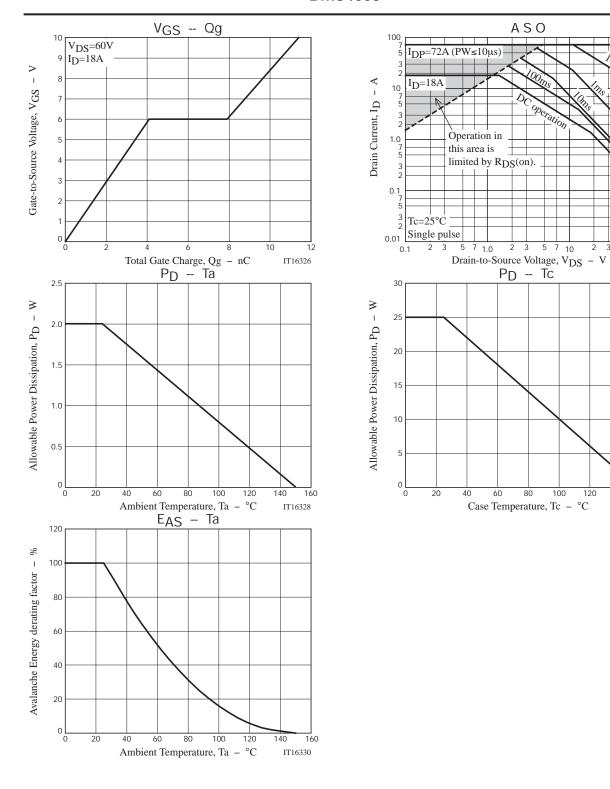


Fig.3 Reverse Recovery Time Test Circuit







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IT16329

Note on usage: Since the BMS4003 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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